

KEMET Part Number: C0805C223J3GALTU
(C0805C223J3GAL7800)

SMD Comm COG SnPb, Ceramic, 0.022 uF, 5%, 25 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805




Dimensions

Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
T	0.9mm +/-0.10mm
S	0.75mm MIN
B	0.5mm +/-0.25mm

Packaging Specifications

Packaging:	T&R, 180mm, Paper Tape
Packaging Quantity:	4000

General Information

Series:	SMD Comm COG SnPb
Style:	SMD Chip
Description:	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features:	Ultra-Stable, Low Loss, Class I
RoHS:	No
Prop 65:	 WARNING: Cancer and reproductive harm - www.p65warnings.ca.gov .
SCIP Number:	5549986b-60cf-4a2a-afbb-4ad1d7a11dcb
Termination:	Lead (SnPb)
Marking:	No
AEC-Q200:	No
Component Weight:	13 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications

Capacitance:	0.022 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	5%
Voltage DC:	25 VDC
Dielectric Withstanding Voltage:	62.5 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor:	0.1% 1 kHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	45.4545 GOhms

单击下面可查看定价，库存，交付和生命周期等信息

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